

## 0.5W Zener Diode - BZX55A\* series

**Rev 1.0** 

0.5W 5mA I<sub>ZT</sub> Silicon Planar Zener diode in bare die form – 1% tolerance, "A" grade 07/04/19

#### Features:

- Tight tolerance reverse breakdown voltage
- Larger die size for dissipation
- I<sub>R</sub> characterized at 125°C
- Sharp reverse characteristics & low reverse current
- High reliability gold back metal

#### **Ordering Information**

The following part suffixes apply:

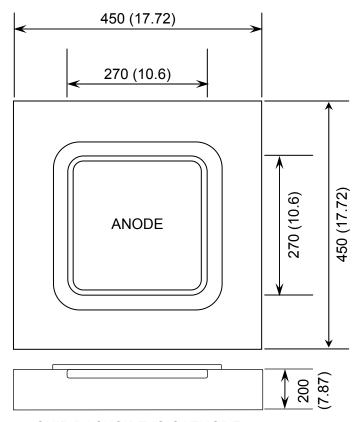
- No suffix MIL-STD-750 /2073 Visual Inspection
- "H" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2072 Visual Inspection+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

### Die Dimensions in µm (mils)



CHIP BACKSIDE IS CATHODE

### **Supply Formats:**

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- Lower precision V<sub>Z</sub> tolerances:

2% - B grade, 5% - C grade

### **Mechanical Specification**

Die Size (Unsawn)	450 x 450 17.72 x 17.72	µm mils		
Anode Pad Size	235 x 235 9.25 x 9.25	µm mils		
Die Thickness	200 7.87	µm mils		
Top Metal Composition	Al			
Back Metal Composition	Au			





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### Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT
Power Dissipation	P <sub>TOT</sub>	500	mW
Junction Temperature	TJ	200	°C
Storage Temperature Range	T <sub>S</sub>	-65 to +200	°C
Forward Voltage @ I <sub>F</sub> = 100mA	V <sub>F</sub>	1.3	V

### Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise stated

DEVICE	ZENER VOLTAGE RANGE		TEST CURRENT		REVERSE LEAKAGE CURRENT			DYNAMIC RESISTANCE		
						I <sub>R</sub> @ V <sub>R</sub>		Z <sub>Z</sub> @ I <sub>ZT1</sub>	Z <sub>ZK</sub> @ I <sub>ZT2</sub>	
	Vz @ I <sub>ZT1</sub>	I <sub>ZT1</sub> I <sub>ZT2</sub>	I <sub>ZT2</sub>	T <sub>A</sub> = 25°C T <sub>A</sub> = 125°C			f = 1 kHz			
	V		mA		μΑ Max.		V	Ω		
	Min.	Nom.	Max.	IIIA		μΑ IVIαX.		V	Max.	Max.
BZX55A10	9.90	10	10.10	5	1	0.1	2.0	7.5	15	70
BZX55A11	10.89	11	11.11	5	1	0.1	2.0	8.2	20	70
BZX55A12	11.88	12	12.12	5	1	0.1	2.0	9.1	20	90
BZX55A13	12.87	13	13.13	5	1	0.1	2.0	10	26	110
BZX55A15	14.85	15	15.15	5	1	0.1	2.0	11	30	110
BZX55A16	15.84	16	16.16	5	1	0.1	2.0	12	40	170
BZX55A18	17.82	18	18.18	5	1	0.1	2.0	13	50	170
BZX55A20	19.80	20	20.20	5	1	0.1	2.0	15	55	220
BZX55A22	21.78	22	22.22	5	1	0.1	2.0	16	55	220
BZX55A24	23.76	24	24.24	5	1	0.1	2.0	18	80	220
BZX55A27	26.73	27	27.27	5	1	0.1	2.0	20	80	220
BZX55A30	29.70	30	30.30	5	1	0.1	2.0	22	80	220
BZX55A33	32.67	33	33.33	5	1	0.1	2.0	24	80	220
BZX55A36	35.64	36	36.36	5	1	0.1	2.0	27	80	220

<sup>1.</sup> Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

Zener Voltages 2.4V to 9.1V are constructed using a smaller die geometry.

Please see here for further details



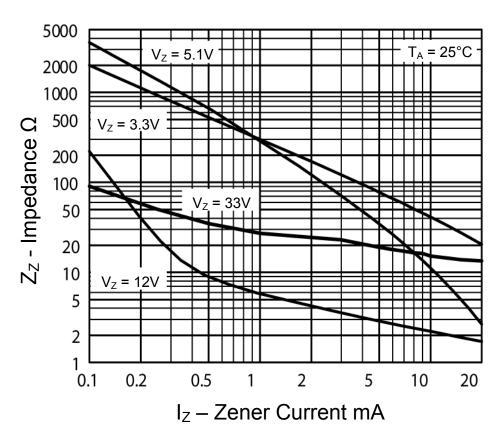
<sup>2.</sup> Assembled in DO-35 package. Performance in die form subject to assembly heat sinking and die attach methods.



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### Typical Electrical Characteristics



Zener Impedance Versus Operating Current -  $Z_Z$  Versus  $I_Z$ 

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